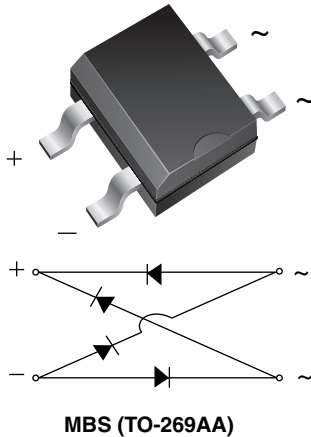


Miniature Glass Passivated Fast Recovery Surface-Mount Bridge Rectifier


MBS (TO-269AA)

LINKS TO ADDITIONAL RESOURCES


[3D Models](#)

PRIMARY CHARACTERISTICS

| | |
|------------------------|----------------|
| $I_{F(AV)}$ | 0.5 A |
| V_{RRM} | 200 V, 400 V |
| I_{FSM} | 30 A |
| t_{rr} | 150 ns |
| V_F at $I_F = 0.4$ A | 1.25 V |
| T_J max. | 150 °C |
| Package | MBS (TO-269AA) |
| Circuit configuration | Quad |

MAXIMUM RATINGS ($T_A = 25$ °C unless otherwise noted)

| PARAMETER | SYMBOL | RMB2S | RMB4S | UNIT |
|--|----------------|--------------------------------------|-------|------------------|
| Device marking code | | 2R | 4R | |
| Maximum repetitive peak reverse voltage | V_{RRM} | 200 | 400 | V |
| Maximum RMS voltage | V_{RMS} | 140 | 280 | V |
| Maximum DC blocking voltage | V_{DC} | 200 | 400 | V |
| Maximum average forward output rectified current at $T_A = 30$ °C | $I_{F(AV)}$ | on glass-epoxy PCB ⁽¹⁾ | | A |
| | | on aluminum substrate ⁽²⁾ | | |
| Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load | I_{FSM} | 30 | | A |
| Rating for fusing ($t < 8.3$ ms) | I^2t | 5.0 | | A ² s |
| Operating junction and storage temperature range | T_J, T_{STG} | -55 to +150 | | °C |

Notes

⁽¹⁾ On glass epoxy PCB mounted on 0.05" x 0.05" (1.3 mm x 1.3 mm) pads

⁽²⁾ On aluminum substrate PCB with an area of 0.8" x 0.8" (20 mm x 20 mm) mounted on 0.05" x 0.05" (1.3 mm x 1.3 mm) solder pad

FEATURES

- UL recognition, file number E54214
- Saves space on printed circuit boards
- Ideal for automated placement
- Fast recovery, low switching loss
- High surge current capability
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912


RoHS
COMPLIANT

TYPICAL APPLICATIONS

General purpose use in AC/DC bridge full wave rectification for power supply, lighting ballaster, battery charger, home appliances, office equipment, and telecommunication applications.

MECHANICAL DATA

Case: MBS (TO-269AA)

Molding compound meets UL 94 V-0 flammability rating Base P/N-E3 - RoHS-compliant, commercial grade

Terminals: matte tin plated leads, solderable per J-STD-002 and JESD22-B102

E3 suffix meets JESD 201 class 1A whisker test

Polarity: as marked on body



| ELECTRICAL CHARACTERISTICS ($T_A = 25\text{ }^\circ\text{C}$ unless otherwise noted) | | | | | |
|--|---|----------|-------|-------|---------------|
| PARAMETER | TEST CONDITIONS | SYMBOL | RMB2S | RMB4S | UNIT |
| Maximum instantaneous forward voltage per diode | $I_F = 0.4\text{ A}$ | V_F | 1.25 | | V |
| Maximum DC reverse current at rated DC blocking voltage per diode | $T_A = 25\text{ }^\circ\text{C}$ | I_R | 5.0 | | μA |
| | $T_A = 125\text{ }^\circ\text{C}$ | | 100 | | |
| Maximum reverse recovery time per diode | $I_F = 0.5\text{ A}$, $I_R = 1.0\text{ A}$, $I_{rr} = 0.25\text{ A}$ | t_{rr} | 150 | | ns |
| Typical junction capacitance per diode | 4.0 V, 1 MHz | C_J | 13 | | pF |

| THERMAL CHARACTERISTICS ($T_A = 25\text{ }^\circ\text{C}$ unless otherwise noted) | | | | |
|---|--------------------------------|-------|-------|--------------------|
| PARAMETER | SYMBOL | RMB2S | RMB4S | UNIT |
| Typical thermal resistance ⁽¹⁾ | $R_{\theta JA}$ ⁽¹⁾ | 85 | | $^\circ\text{C/W}$ |
| | $R_{\theta JA}$ ⁽²⁾ | 70 | | |
| | $R_{\theta JL}$ ⁽¹⁾ | 20 | | |

Notes

⁽¹⁾ On glass epoxy PCB mounted on 0.05" x 0.05" (1.3 mm x 1.3 mm) pads

⁽²⁾ On aluminum substrate PCB with an area of 0.8" x 0.8" (20 mm x 20 mm) mounted on 0.05" x 0.05" (1.3 mm x 1.3 mm) solder pad

| ORDERING INFORMATION (Example) | | | | |
|---------------------------------------|-----------------|------------------------|---------------|----------------------------------|
| PREFERRED P/N | UNIT WEIGHT (g) | PREFERRED PACKAGE CODE | BASE QUANTITY | DELIVERY MODE |
| RMB4S-E3/45 | 0.22 | 45 | 100 | Tube |
| RMB4S-E3/80 | 0.22 | 80 | 3000 | 13" diameter paper tape and reel |

RATINGS AND CHARACTERISTICS CURVES ($T_A = 25\text{ }^\circ\text{C}$ unless otherwise noted)

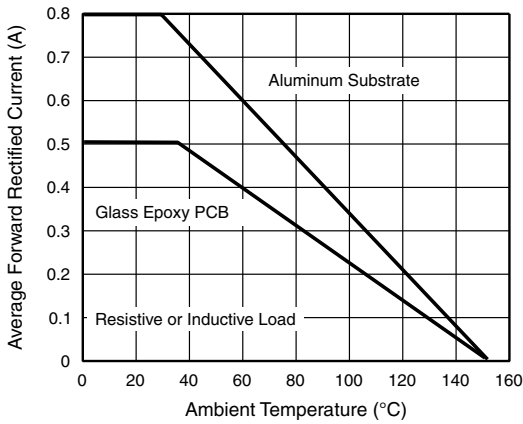


Fig. 1 - Maximum Forward Current Derating Curve

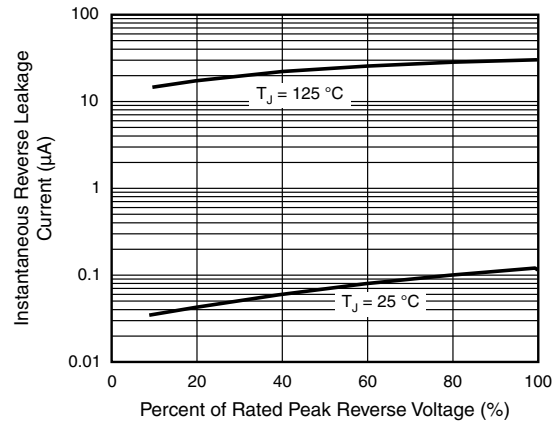


Fig. 4 - Typical Reverse Leakage Characteristics Per Diode

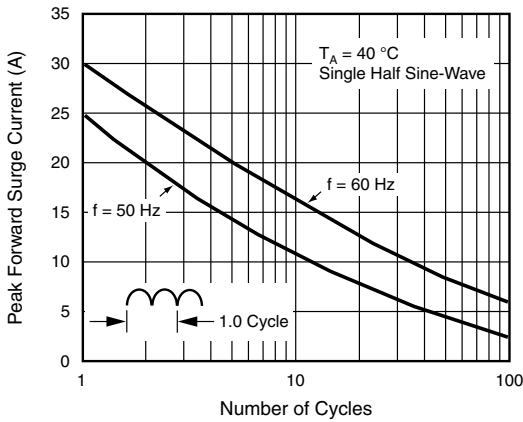


Fig. 2 - Maximum Non-Repetitive Peak Forward Surge Current Per Diode

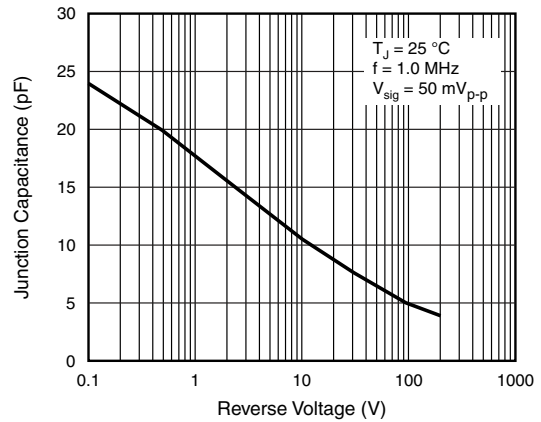


Fig. 5 - Typical Junction Capacitance Per Diode

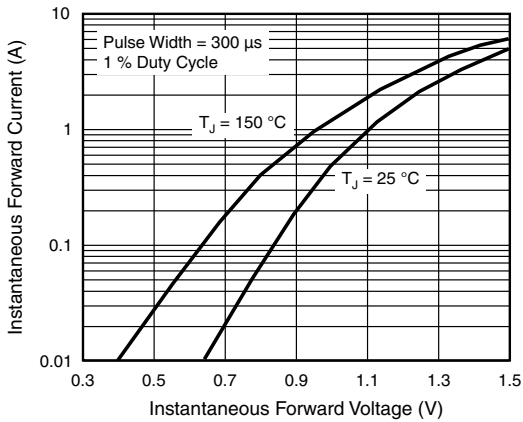
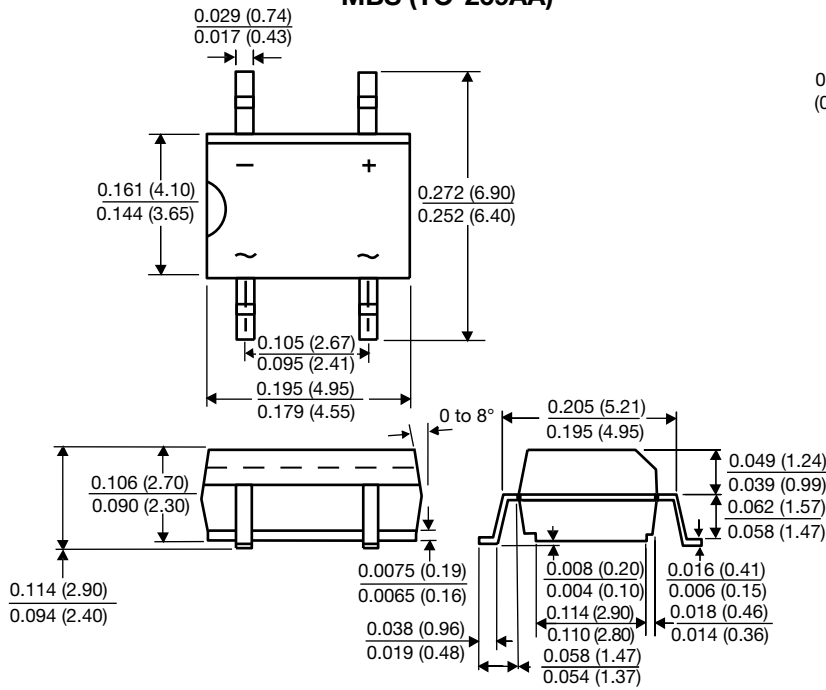


Fig. 3 - Typical Instantaneous Forward Characteristics Per Diode

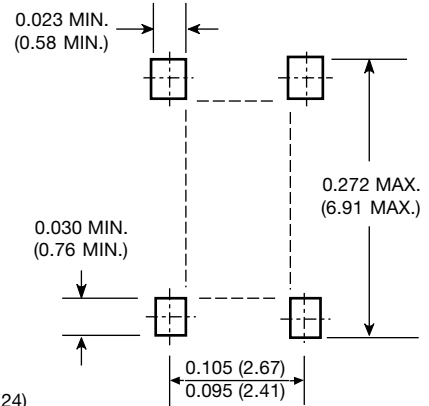


PACKAGE OUTLINE DIMENSIONS in inches (millimeters)

MBS (TO-269AA)



Mounting Pad Layout





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